

(0,80 mm) .0315"

SLIM BODY GROUND PLANE HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QRM8

Insulator Material:
Black LCP
Terminal & Ground
Plane Material:
Phosphor Bronze
Plating:
Au or Sn over
50µ" (1,27 µm) Ni
Current Rating:
Contact:
2.2 A per pin
(1 pin powered per row)
Ground:
8.5 A per ground plane
(1 ground plane powered)
Operating Temp Range:
-55°C to +125°C
Voltage Rating:
215 VAC

Processing: Lead-Free Solderable:

RoHS Compliant:

Yes

Yes
SMT Lead Coplanarity:

(0,10 mm) .004" max (018-026) (0,15 mm) .006" max (036-078)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

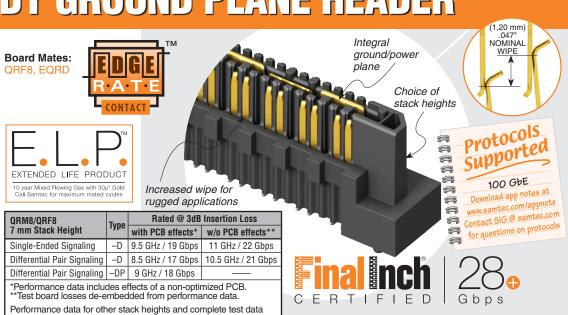
• Other platings Contact Samtec.

MATED HEIGHT*		
QRM8 LEAD	QRF8 LEAD STYLE	
STYLE	-05.0	-07.0
-02.0	(7,00) .276	(9,00) .354
-05.0	(10,00) .394	(12,00) .472
-07.0	(12,00) .472	(14,00) .551

*Processing conditions will affect mated height.

Note: Patented

Note: Some lengths, styles and options are non-standard, non-returnable.



-026, -052, -078 (52 total pins per bank = -D)

QRM8

available at www.samtec.com?QRM8 or contact sig@samtec.com

PINS PER ROW

NO. OF PAIRS

-018, -036, -054(18 pairs per bank = -D-DP)

-02.0

LEAD

STYLE

= 2 mm

Body Height
(Not available
with -054 &
-078 positions)

-05.0 = 5 mm Body Height

-07.0 = 7 mm Body Height — L = 10μ" (0,25 μm) Gold on contact, Matte Tin on tail

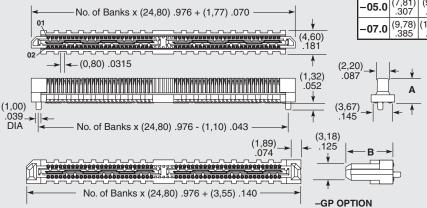
PLATING

OPTION

-D = Single-Ended -D-DP = Differential Pair

TYPE

LEAD STYLE A B
-02.0 (4,81) (6,12) .241
-05.0 (7,81) (9,12) .359
-07.0 (9,78) (11,12) .385 .438



_GP

OTHER

OPTION

= Guide Post (Requires –GP on mating connector)

–K

= (5,00 mm) .197" DIA Polyimide Film Pick & Place Pad

$-\mathsf{TR}$

= Tape & Reel (-018, -026, -036, -052 only)



SAMTEC

- Edge Rate[™] contacts
- Increased contact wipe
- 10 year MFG
- · Guide post option